

CIN: U65993GJ2007PLC051028 RBI Registration Number: N.01.00477 PAN Number: AABCH8761M

(Incorporated on June 4, 2007, in Ahmedabad, in the name of HDB Financial Services Limited a company within the meaning of the Companies Act, 1956 and registered with the Reserve Bank of India as a Non-Banking Financial Company) Registered Office: Radhika, 2nd Floor, Law Garden Road, Navrangpura, Ahmedabad – 380 009 Tel: +91 079-30482717 Corporate Office: Ground Floor, Zenith House, Keshavrao Khadye Marg, Opp. Race Course, Mahalaxmi, Mumbai – 400034; Tel: 022- 49116300:

Fax: 022-49116666; Website: www.hdbfs.com;
Compliance Officer: Ms. Dipti Khandelwal, Contact details of Compliance Officer: 022-49116368

e-mail: compliance@hdbfs.com

Tranche Placement Memorandum for Series 2022 / 181 under Shelf Placement Memorandum dated April 22, 2022

Date: July 06, 2022

Type of Placement Memorandum: Private Placement

Private Placement of upto 10000 (including Green Shoe Option) Secured, Rated, Listed, Redeemable Non-Convertible Debentures ("Series 2022 / 181 Debentures") of the face value of Rs. 10,00,000/- (Rupees Ten Lakh only) each for cash aggregating upto Rs. 50,00,00,000/- (Rupees Fifty Crore Only) with Green Shoe Option of upto Rs. 950,00,00,000/- (Rupees Nine Hundred Fifty Crore Only) to retain total subscription upto Rs. 1000,00,00,000/- (Rupees One Thousand Crore only) issued under the Shelf Placement Memorandum dated April 22, 2022 as amended / supplemented from time to time.

This Tranche Placement Memorandum is issued pursuant the terms of the Shelf Placement Memorandum dated April 22, 2022. All the terms, conditions, information and stipulations contained in the Shelf Placement Memorandum are incorporated herein by reference as if the same were set out herein. Investors are advised to refer to the same. This Tranche Placement Memorandum must be read in conjunction with the Shelf Placement Memorandum and the Private Placement Offer Cum Application Letter. All capitalised terms used but not defined herein shall have the meaning ascribed to them in the Shelf Placement Memorandum.

This Tranche Placement Memorandum contains details of this Tranche of private placement of Series 2022 / 181 Debentures and any material changes in the information provided in the Shelf Placement Memorandum, as set out herein. Accordingly, set out below are the updated particulars / changes in the particulars set out in the Shelf Placement Memorandum, which additional / updated information / particulars shall be read in conjunction with other information / particulars appearing in the Shelf Placement Memorandum. All other particulars appearing in the Shelf Placement Memorandum shall remain unchanged.

The Issue does not form part of non-equity regulatory capital mentioned under Chapter V (Issuance and Listing of perpetual debt instruments, perpetual non-cumulative preference shares and similar instruments) of SEBI (Issue and Listing of Non-Convertible Securities) Regulations, 2021. The face value of each Debenture issued on private placement basis under this Tranche Placement Memorandum shall be Rs.10,00,000/-.

CREDIT RATING

Details of credit rating, along with the latest press release of the Credit Rating Agency in relation to the issue and declaration that the rating is valid as on the date of issuance and listing. Such press release shall not be older than one year from the date of opening of the issue:

CARE Ratings Limited has assigned a "CARE AAA Stable" (pronounced "CARE Triple A with stable outlook") and CRISIL Ratings Limited has assigned a "CRISIL AAA/Stable" (pronounced "CRISIL Triple A with stable outlook") rating to the captioned Issue. As per CARE and CRISIL's rating letter(s), instruments with this rating are considered to have a high degree of safety regarding timely servicing of financial obligations and such instruments carry very low credit risk. Investors may please note that the rating is not a recommendation to buy, sell or hold securities and investors should take their own decisions. The rating agency has the right to suspend, withdraw or revise the rating / outlook assigned to the Issue at any time, on the basis of new information or unavailability of information or other circumstances which the rating agency believes may have an impact on the rating

Date of Rating Letters: June 30, 2022 by CARE Ratings Limited and June 29, 2022 by CRISIL Ratings Limited Date of Press Release of Ratings: September 23, 2021 & October 13, 2021 by CARE Ratings Limited and August 13, 2021 by CRISIL Ratings

Press Release and Rating Rationale: Please refer Annexure II

Declaration: The rating mentioned above are valid as on the date of issuance and listing.

SECTION I

UPDATED FINANCIAL INFORMATION

Any changes in Section F (Financial Information) of the Shelf Placement Memorandum:

I. Gross Debt: Equity Ratio of the Company

Before the Issue	5.89%
After the Issue	6.00%

II. A columnar representation of the audited financial statements (i.e. Profit & Loss statement, Balance Sheet and Cash Flow statement) both on a standalone and consolidated basis for a period of three completed years which shall not be more than six months old from the issue opening date, as applicable.

Standalone Audited Financial Statement

There is no change in the audited financial statements provided in the Shelf Placement Memorandum.

Consolidated

As on even date the Issuer does not have any subsidiary. The standalone and consolidated financial information would be the same and the Financial Information as disclosed above shall apply.

III. Unaudited financial information for stub period.

[Listed issuers (whose debt securities or specified securities are listed on recognised stock exchange(s)) in compliance with the Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015, may disclose unaudited financial information for the stub period in the format as prescribed therein with limited review report in the placement memorandum, as filed with the stock exchanges, instead of audited financial statements for stub period, subject to making necessary disclosures in this regard in placement memorandum including risk factors.]

Not Applicable

Private and Confidential – For Private Circulation Only
Tranche Placement Memorandum for Issue of
Secured Rated Listed Redeemable Non-Convertible Debentures
on a Private Placement Basis
July 06, 2022

(iii) Key Operational and Financial Parameters on a Consolidated and Standalone Basis:

<u>For Financial Sector Entities:</u> Standalone Basis (Rs. in Crore)

There is no change in the Key Operational and Financial Parameters provided in the Shelf Placement Memorandum dated April 22, 2022.

Key Operational and Financial Parameters on a Consolidated Basis:

As on date the Issuer does not have any subsidiary. The standalone and consolidated financial information would be the same and the Financial Information as disclosed above shall apply.

IV. Any other changes

Any other changes in the information contained in the Shelf Placement Memorandum:

SECTION II

OTHER MATERIAL CHANGES

Any other material changes in the information contained in the Shelf Placement Memorandum:

I. Changes in Section A of the Shelf Placement Memorandum:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

II. Changes in Section D of the Shelf Placement Memorandum:

Details of Statutory Auditors:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

III Changes in Section E of the Shelf Placement Memorandum:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

IV Changes in Section E of the Shelf Placement Memorandum:

a) Details of Share Capital as at year ended, i.e. March 31, 2022:-

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

b) Changes in its capital structure as at year ended, i.e. March 31, 2022 for the last three years:-

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

c) Equity Share Capital History of the Company for the last 3 (three) years

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

d) Details of any Acquisition or Amalgamation in the last 1 year:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

e) Details of any Reorganization or Reconstruction in the last 1 year:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

f) Details of the shareholding of the Company as at year ended, i.e. March 31, 2022 as per the format specified under the listing regulations:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

g) List of top 10 holders of equity shares as at year ended, i.e. March 31, 2022

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

h) Details of the current directors of the Company as on date:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

Details of change in directors since last three years:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

j) Following details regarding the auditors of the Company:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

k) Details of change in auditor since last three years:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

- l) Details of the following liabilities of the Issuer, as at year ended, i.e. March 31, 2022 or if available, a later date:
- Details of Outstanding Secured Loan Facilities –

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

ii. Details of Outstanding Unsecured Loan Facilities: -

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

iii. Details of Outstanding Non-Convertible Securities:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

Details of Subordinated Bonds:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

Details of Perpetual Debt Instruments:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

iv. List of top 10 holders of non-convertible securities in terms of value (in cumulative basis)

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

v. Details of outstanding Commercial Paper as at the end of the last quarter in the following format:-

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

vi. Details of the Rest of the borrowing (if any including hybrid debt like FCCB, Optionally Convertible Debentures / Preference Shares):-

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

vii. Details of all default/s and/or delay in payments of interest and principal of any kind of term loans, debt securities and other financial indebtedness including corporate guarantee issued by the Company, in the past 3 years including the current financial year.

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

viii. Any material event/ development or change having implications on the financials/credit quality (e.g. any material regulatory proceedings against the Issuer/promoters, litigations resulting in material liabilities, corporate restructuring event etc) at the time of issue which may affect the issue or the investor's decision to invest / continue to invest in the non-convertible securities.

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

ix. Any litigation or legal action pending or taken by a Government Department or a statutory body during the last three years immediately preceding the year of the issue of the Shelf Placement Memorandum against the promoter of the Company.

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

x. Details of default and non-payment of statutory dues

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

xi. The names of the debenture trustee(s) shall be mentioned with statement to the effect that debenture trustee(s) has given its consent for appointment along with the copy of the consent letter from the debenture trustee.

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

xii. If the security is backed by a guarantee or letter of comfort or any other document / letter with similar intent, a copy of the same shall be disclosed. In case such document does not contain detailed payment structure (procedure of invocation of guarantee and receipt of payment by the investor along with timelines), the same shall be disclosed in the offer document.

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

V Changes in Section E of the Shelf Placement Memorandum:

Disclosure of latest ALM statements to stock exchange:

https://www.hdbfs.com/sites/default/files/debt/Letter for ALM statement NSE MAY 2022.pdf

VI Changes in Section E of the Shelf Placement Memorandum:

Same as mentioned in Shelf Placement Memorandum dated April 22, 2022

VII Changes in Annexure VII of the Shelf Placement Memorandum:

The number of persons to whom allotment on preferential basis/private placement/ rights issue has already been made during the year, in terms of number of securities as well as price

Type of security	Nature of Issue	Number of Investors	No of Securities	Issue Price (In Rs.)
Non Convertible Debenture	Private Placement	4	523	10,48,869.30
Non Convertible Debenture	Private Placement	14	7500	9,73,567.00
Non Convertible Debenture	Private Placement	1	900	9,90,249.32
Non Convertible Debenture	Private Placement	2	1300	9,63,241.00
Non Convertible Debenture	Private Placement	5	3500	10,00,000.00

The pre-issue and post issue shareholding pattern of the company (as on June 30, 2022)

		Pre-	issue	Po	ost-issue	
Sr. No	Category	No. of shares held	(%) of shareholding	No. of shares held	(%) of shareholding	
Α	Promoters' holding					
1	Indian					
	Individual	-	-			
	Bodies Corporate	75,05,96,670	94.96			
	Sub-total	75,05,96,670	94.96			
2	Foreign promoters	-	-			
	Sub-total (A)	75,05,96,670	94.96	9.		
В	Non- promoters' holding	£ .			f the Company	
1	Institutional Investors	11,00,000	0.14	after the Issue. The Debentures being non- convertible, there will b no change in the paid- up capital due to conversion and there will be no change in the		
2	Non- Institutional Investors	-	-			
	Private Corporate Bodies	8,04,975	0.10			
	Directors and relatives	7,50,500	0.09			
	Indian public	3,58,39,591	4.53			
	Others (including Non- resident Indians)	13,48,295	0.17			
	Sub-total (B)	3,98,43,361	5.04			
	GRAND TOTAL	79,04,40,031	100.00			

SECTION II

SUMMARY TERM SHEET

Series 2022 / 181 - Series 2022 A/0(ZC)/181_Option 1

Series 2022 / 181 - Series 2022 A/1(FX)/181 Option 2

Security Name (Name of the non-convertible securities which includes (Coupon / dividend, Issuer Name and maturity year) e.g. 8.70% XXX 2015.	HDB/0%/Premium/2025_ Series 2022 A/0(ZC)/181_Option 1	HDB/7.70%/Annual/2025_ Series 2022 A/1(FX)/181_Option 2
Issuer	HDB Financial Services Limited	
Type of Instrument	Secured, Rated, Listed, Redeemable, Non-co	nvertible Debentures
Nature of Instrument	Secured	
Seniority	Senior	
Mode of Issue	Private placement	
Eligible Investors	Please refer paragraph "Who can apply" of 2022	the Shelf Placement Memorandum dated April 22
Details of Arrangers (if any)	1.Name: A. K. Capital Services Limited Regd. Address: 603, 6th Floor, Windsor, Off Cs	st Road, Kalina, Santacruz (Fast), Mumbai –

Regd. Address: 603, 6th Floor, Windsor, Off Cst Road, Kalina, Santacruz (East), Mumbai – 400098, India

Corporate Address: 603, 6th Floor, Windsor, Off Cst Road, Kalina, Santacruz (East), Mumbai – 400098, India

Name of contact person: Ms. Shraddha Joshi E-mail: shraddha.joshi@akgroup.co.in

Fax: +91-22-66100594

Tel No: Board: +91-22-67546500 Website: www.akgroup.co.in

2. Name: IIFL Wealth Management Ltd



Regd. Address: 6th Floor, IIFL Centre, Kamala City, Senapati Bapat Marg, Lower Parel (W), Mumbai 400 013, Maharashtra, India.

Corporate Address: 6th Floor, IIFL Centre, Kamala City, Senapati Bapat Marg, Lower Parel (W), Mumbai 400 013, Maharashtra, India. Name of contact person: Rahul Gupta/Amita Somani

E-mail: debttrading@iiflw.com

Fax: 022-46464706

Tel No: 022-48765624/022-48765229 Website: https://www.iiflwealth.com/

3. Name: ARETE Securities Ltd

ARETE SECURITIES LTD

Erstwhile SPA Securities Ltd.

Regd. Address: 101-A, 10th Floor, Mittal Court Nariman Point, Mumbai - 400021 Corporate Address: 101-A, 10th Floor, Mittal Court Nariman Point, Mumbai - 400021

Name of contact person: Mr. Ashish Jalan E-mail: ashish.jalan@aretesecurities.com

Fax: 022- 22801247 Tel No: Board: 022-40460460

Website: www.aretesecurities.com

4. Name: Trust Investment Advisors Private Limited



Regd. Address: 109/110, 1st Floor, Balarama, Bandra Kurla Complex, Bandra (East), Mumbai -

400051

Corporate Address: 1101, Naman Centre, Bandra Kurla Complex, Bandra (East), Mumbai -

400051.

Name of contact person: Mr. Parth Doctor

E-mail: mbd.trust@trustgroup.in
Tel No: +91 022 4084 5000
Website www.trustgroup.in

5. Name: PNB Gilts Ltd.



Regd. Address: 4th Floor, PNB House, Sir P.M. Road, Fort, Mumbai - 400 001 Corporate Address: 4th Floor, PNB House, Sir P.M. Road, Fort, Mumbai - 400 001

Name of contact person: Mr. Uttam Kumar Saha

E-mail: mumbai@pnbgilts.com Tel No: 022-2269 1809 / 10 Website www.pnbgilts.com

6. Name: Yes Bank Ltd.



Regd. Address: YES Bank Limited.

Financial Markets, Yes Bank House, 2nd Floor, South Wing, Off Western Express Highway,

Santacruz (East), Mumbai-400055 Name of contact person: Mr. Salil Kumar

E-mail: DCM@yesbank.in

Fax: 022-50919945 Tel No: Board: 022-50919947

Website: www.yesbank.in

The Series 2022/181 Debentures is proposed to be listed on the Wholesale Debt Market (WDM) Segment of the BSE Ltd. within a maximum period of 4 (Four) trading days from the Issue Closing Date. BSE has given its in-principle approval to list the NCDs issued under this Tranche in terms of the Shelf Placement Memorandum vide its letter dated Monday, July 04, 2022.

Listing

Rating of the Instrument	Tranche Debentures beyond 4 (Four) trading (i) make payment to the Debenture Holders of from the Deemed Date of Allotment till the list to utilize the issue proceeds of its subsequent having received final listing approval from BS CARE Ratings Ltd. has assigned a "CARE A outlook") and CRISIL Ratings Limited has as Triple A with stable outlook), to the long aggregating upto Rs.10,000 Crore, of the Cohave high degree of safety regarding timely	ns, in case of a delay by the Company in listing this days from the Issue Closing Date, the Company shall f 1% (One Percent) per annum over the Coupon Rate ing of such Tranche Debentures; and (ii) be permitted two privately placed issuances of securities only after E in respect of the listing of the Tranche Debentures. AA; Stable" (pronounced "CARE Triple A with stable ssigned a "CRISIL AAA/Stable" (pronounced "CRISIL term Non-Convertible Debenture issue programme mpany. Instruments with this rating are considered to a servicing of financial obligations. Such instruments		
Issue Size	carry very low credit risk. The aggregate size of the Issue is for upto Rs. 10,000,00,00,000/- (Rupees Ten Thousand Crores only) out of which this Issue of Series 2022/181 Debentures is for upto Rs. 50,00,00,000/- (Rupees Fifty Crore Only) with Green Shoe Option of upto Rs. 950,00,00,000/- (Rupees Nine Hundred Fifty Crore Only) to retain total subscription upto Rs. 1000,00,00,000/- (Rupees One Thousand Crore only) in the manner as specified in the Section 'Base Issue and Green Shoe Option' below.			
Option to retain	Yes, Green Shoe Option of upto Rs. 950,00,0	00,000/- (Rupees Nine Hundred Fifty Crore Only)		
oversubscription (Amount)		9		
Base Issue and Green Shoe Option	Rs. 25,00,00,000/- (Rupees Twenty-Five Crore Only) with Green Shoe Option of upto Rs. 475,00,00,000/- (Rupees Four Hundred Seventy-Five Crore Only) to retain total subscription upto Rs. 500,00,000,000/- (Rupees Four Hundred Seventy-Five Crore Only) to retain total subscription upto Rs. 500,00,00,000/- (Rupees Five Hundred Crore only)			
Minimum Subscription	Rs. 1,00,00,000/- (Rupees One Crore Only) i	i.e. 10 Debentures		
Objects of the Issue / Purpose for which there is requirement of funds	The proceeds of the Issue comprising of this Tranche would be utilised by the Company, inter-alia, for disbursements of loans to borrowers, refinancing existing borrowings/ repayment of existing borrowings, and for general corporate purposes of the Company. The funds raised through the Issue will be utilized as per the section "Utilisation of the Proceeds" stipulated below.			
Details of the utilization of the Proceeds.		runds raised through the Issue as mentioned below:		
(The Issuer shall provide granular disclosures in their	Purpose	Percentage of fund raised (%)		
placement memorandum, with regards to the "Object of	For disbursements of loans to borrowers	Upto 100		
the Issue" including the percentage of the issue proceeds earmarked for each	For refinancing existing borrowings/ repayment of existing borrowings	Upto 75		
of the "object of the issue".)	For general corporate purposes	Upto 50		
	finance to NBFC. Further, pending utilisation, the issue proceed	accordance with RBI guidelines applicable for bank ds may be utilized / invested as may be approved from s, in fixed deposits with banks, mutual fund units, etc.		
In case the Issuer is a NBFC and the objects of the issue entail loan to any entity who is a 'group company' then disclosures shall be made in the following format:	The proceeds of the Issue will not be utilised			

Consolidation of ISINs		ed to add additional securities (for such additional m time to time) to the existing ISINs from time to
International Data		7.7000% p.a.
Interest/Coupon Rate Step Up/Step Down Coupon	Zero Coupon N.A.	7.7000% p.a.
Rate	IV.A.	
Coupon Payment Frequency	N.A.	Payable Annually
Coupon Payment Dates	N.A.	Thursday, 11 August, 2022
		Friday, 11 August, 2023
		Sunday, 11 August, 2024
		& on maturity Monday, 11 August, 2025
Coupon Type	N.A.	Fixed
Coupon Reset Process	N.A.	
(including rates, spread,		
effective date, interest rate cap and floor etc.).		
Day Count Basis	Actual/ Actual	
Interest on Application Money		to deduction of income tax under the provisions of
,	the Income Tax Act, 1961, or any other state applicable) will be paid to the applicants on the applicable will be paid to the applicants on the applicable the period starting from and including the date of bank account up to one day prior to the Deemed	tutory modification or re-enactment thereof, as application money for the Tranche Debentures for of realization of application money in the Issuer's Date of Allotment.
Default Interest Rate	Debentures on the respective due dates, additio	If or redemption of the principal amount of the nal interest of 2% (Two Percent) per annum over y the Company for the defaulting period until the y is paid.
	Act, the Company shall also pay interest of 2%	(Two Percent) per annum or such other rate, as
Tenor	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Ho	eed within the period specified in the Companies (Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the 1131 days from the deemed date of allotment i.e. Thursday, July 07, 2022
	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Hoexecution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the 1131 days from the deemed date of allotment
Tenor Redemption Date Redemption Amount	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Hoexecution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the 1131 days from the deemed date of allotment i.e. Thursday, July 07, 2022
Redemption Date Redemption Amount Redemption Premium/	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture He execution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the 1131 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, August 11, 2025 Rs.10,00,000/- (Rupees Ten Lakhs Only) pe
Redemption Date Redemption Amount	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Hoexecution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety Seven Only) per Debenture	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the 1131 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, August 11, 2025 Rs.10,00,000/- (Rupees Ten Lakhs Only) pe Debenture
Redemption Date Redemption Amount Redemption Premium/ Discount Issue Price Pay-in Amount	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Hollowship execution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety Seven Only) per Debenture Premium Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, as solders, over and solders and solders. Thursday, July 07, 2022 Monday, August 11, 2025 Rs.10,00,000/- (Rupees Ten Lakhs Only) pe Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) pe Debenture
Redemption Date Redemption Amount Redemption Premium/ Discount Issue Price	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Hollowship execution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety Seven Only) per Debenture Premium Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, over an above the Coupon Rate, as solders, as solders, over and above the Coupon Rate, as solders, as solders, as solders, as solders, over and above the Coupon Rate, as solders, as s
Redemption Date Redemption Amount Redemption Premium/ Discount Issue Price Pay-in Amount Premium /Discount at which security is issued and the effective yield as a result of	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Hollowship execution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety Seven Only) per Debenture Premium Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, as solders, over an above the Coupon Rate, as solders, as solders, as solders, as solders, over and above the Coupon Rate, as solders,
Redemption Date Redemption Amount Redemption Premium/ Discount Issue Price Pay-in Amount Premium /Discount at which security is issued and the effective yield as a result of such Premium /discount. Put Option Date	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Holeschied by SEBI to the Tranche Debenture of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety Seven Only) per Debenture Premium Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture N.A.	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, as solders, over an above the Coupon Rate, as solders, as solders, as solders, as solders, over and above the Coupon Rate, as solders,
Redemption Date Redemption Amount Redemption Premium/ Discount Issue Price Pay-in Amount Premium /Discount at which security is issued and the effective yield as a result of such Premium /discount. Put Option Date Put Option Price	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Holesceution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety Seven Only) per Debenture Premium Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture N.A.	(Two Percent) per annum or such other rate, a olders, over and above the Coupon Rate, till the 1131 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, August 11, 2025 Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture N.A. Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture
Redemption Date Redemption Amount Redemption Premium/ Discount Issue Price Pay-in Amount Premium /Discount at which security is issued and the effective yield as a result of such Premium /discount. Put Option Date Put Option Price Call Option Date	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Hollowship execution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety Seven Only) per Debenture Premium Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture N.A. N.A.	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, as solders, over an above the Coupon Rate, as solders, as solders, as solders, as solders, over and above the Coupon Rate, as solders,
Redemption Date Redemption Amount Redemption Premium/ Discount Issue Price Pay-in Amount Premium /Discount at which security is issued and the effective yield as a result of such Premium /discount. Put Option Date Put Option Price	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Hollowship execution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety Seven Only) per Debenture Premium Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture N.A. N.A. N.A. N.A. N.A. N.A.	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, as solders, over an above the Coupon Rate, as solders, as solders, as solders, as solders, over and above the Coupon Rate, as solders,
Redemption Date Redemption Amount Redemption Premium/ Discount Issue Price Pay-in Amount Premium /Discount at which security is issued and the effective yield as a result of such Premium /discount. Put Option Date Put Option Price Call Option Date Call Option Price	Act, the Company shall also pay interest of 2% specified by SEBI to the Tranche Debenture Hollowship execution of the Trust Deed. 1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022 Monday, July 07, 2025 Rs. 12,49,497/- (Rupees Twelve Lakhs Forty Nine Thousand Four Hundred and Ninety Seven Only) per Debenture Premium Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture N.A. N.A. N.A. N.A.	(Two Percent) per annum or such other rate, as olders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, till the solders, over and above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, over an above the Coupon Rate, as solders, over an above the Coupon Rate, as solders, as solders, as solders, over an above the Coupon Rate, as solders, as solders, as solders, as solders, over and above the Coupon Rate, as solders,

Face Value	Rs. 10,00,000/- (Rupees Ten Lakhs Only) per Debenture
Minimum Application and in multiples of Debt	10 Debentures and in multiples of 1 Debenture thereafter.
securities thereafter	
Issue Timing	10:00 am to 11:00 am on BSE EBP
Issue/ Bid Opening Date	Wednesday, July 06, 2022
Issue/ Bid Closing Date	Wednesday, July 06, 2022
Date of earliest closing of the	NA
issue, if any.	
Pay-in Date	Thursday, July 07, 2022
Deemed Date of Allotment	Thursday, July 07, 2022
Issuance mode of the Instrument	Demat only
Trading mode of the Instrument	Demat only
Settlement mode of the Instrument	The pay-in of subscription monies for the Tranche Debentures shall be made by way of transfer of funds from the bank account(s) of the eligible investors (whose bids have been accepted) as registered with the EBP into the account of the relevant clearing corporation, as specified below. For amounts payable by the Issuer to any Debenture Holder pursuant to the terms of the Transaction Documents, Cheque(s)/ electronic clearing services (ECS)/credit through RTGS system/funds transfer to the specified bank account of the Debenture Holder shall be the mode of settlement.
Depository(ies)	NSDL and CDSL
Business Day	Means any day of the week (excluding non-working Saturdays, Sundays and any day which is a public holiday for the purpose of Section 25 of the Negotiable Instruments Act, 1881 (26 of 1881) (as may be amended/supplemented from time to time) in Mumbai and any other day on which banks are closed for customer business in Mumbai) on which the money market is functioning in Mumbai and "Business Days" shall be construed accordingly.
Business Day Convention	If any Coupon Payment Date in respect of the Tranche Debentures falls on a day which is not a Business Day, then the immediately succeeding Business Day shall be the due date for such payment, however, the dates of the future Coupon payments in respect of such Tranche Debentures would be as per the schedule originally stipulated in the relevant Tranche Placement Memorandum. In other words, the subsequent Coupon payment schedule would not be disturbed merely because the payment date in respect of one particular Coupon payment has been postponed earlier because of it having fallen on non-Business Day. If the Maturity Date / Redemption Date (including the last Coupon Payment Date) or the due date in respect of liquidated damages (if any) and all other monies payable under Tranche Debentures falls on a day which is not a Business Day, then the immediately preceding Business Day shall be the due date for such payment.
Disclosure of Interest/Dividend / redemption dates	Please see the section on 'Coupon Rate' and 'Redemption Date' above.
Record Date	The date which will be used for determining the Debenture Holder(s) who shall be entitled to receive the amounts due on any due date, which shall be the date falling 15 (Fifteen) calendar days prior to any due date.
All covenants of the issue (including side letters, accelerated payment clause, etc.)	As set out in Note 1 to the 'Summary Term Sheet' under the Shelf Placement Memorandum.
Description regarding Security (where applicable) including type of security (movable/immovable/tangible etc.), type of charge (pledge/ hypothecation/ mortgage etc.), date of creation of	Description of Security The Debentures being issued under this Tranche Placement Memorandum shall be secured through first and exclusive charge by hypothecation over the specific identified receivables of the Issuer or such other security as may be identified by the Company as set out in the Debenture Trust Deed and/ or the Deed of Hypothecation.

Series 2022 / 181 – i. Series 2022 A/0(ZC)/181_Option 1_4 ii. Series 2022 A/1(FX)/181_ Option 2_2

security/likely date of creation of security, minimum security cover, revaluation, replacement of security, interest to the debenture holder over and above the coupon rate as specified in the Trust Deed and disclosed in the Offer Document/Shelf Placement Memorandum.

Asset Cover and its maintenance

The Company shall, during the currency of the Debentures, maintain a minimum asset cover which shall be 1.10 (One decimal point One Zero) times of the outstanding principal amount and the accrued Coupon, or such other asset cover as may be required in relation to a particular Tranche under the relevant Tranche Placement Memorandum ("Asset Cover").

The Company shall, prior to the issue of Tranche Debentures, provide the Trustee with a Supplemental Receivables Schedule identifying the aggregate Receivables that are charged in favour of the Trustee so as to maintain the required Asset Cover in accordance with the terms of the Debenture Trust Deed or the relevant Tranche Placement Memorandum. Each Supplemental Receivables Schedule shall form an integral part of the Deed of Hypothecation and a first ranking and exclusive continuing charge in the nature of a hypothecation shall be deemed to be *ipso facto* created and perfected over the receivables identified and set out therein, without requiring any further act to be done by the Company.

Within 30 (Thirty) days from the end of each financial quarter or at such other time as may be necessary, the Company shall deliver to the Trustee, the Supplemental Receivables Schedule duly certified by a practicing chartered accountant and the managing director of the Company of aggregate receivables hypothecated on exclusive basis in favour of the Trustee which shall provide requisite Asset Cover on the outstanding Debentures and shall certify its value. It is clarified that if the value of the Hypothecated Assets identified under Schedule I of the Deed of Hypothecation and in the Supplemental Receivables Schedules (as defined in the Deed of Hypothecation) submitted from time to time gets diminished, the Company shall within 30 (Thirty) calendar days from the end of each financial guarter ("Top-Up Date") also provide the Trustee with a Supplemental Receivables Schedule identifying further Receivables (i.e. an updated list of the Loans comprising the Receivables on quarterly basis along with such other certifications in respect of the Loans constituting the Receivables as may be required by Trustee) so as to maintain the Asset Cover in accordance with the terms of the Trust Deed or the relevant Tranche Placement Memorandum. Pursuant to the Top-up, the Company shall take all steps necessary to perfect such security at its own cost including filing the necessary forms for recording the modification of the charge with the applicable registrar of companies.

Any substitution, addition and/or replacement of the Hypothecated Assets shall be made under the terms of the Deed of Hypothecation.

The Company hereby undertakes that the Receivables on which charge has been created are free from any encumbrances.

Release of Excess Hypothecated Assets

Notwithstanding anything contained in the Deed of Hypothecation, in the event that the Hypothecated Assets are of a book value greater than that required for the maintenance of the Asset Cover, the Company shall be entitled to require the Trustee to release the excess Hypothecated Assets such that the Hypothecated Assets remaining after such release would be sufficient for maintenance of the Asset Cover ("Released Assets"). The Company shall, for such release, issue a letter to the Trustee substantially in the format set out in Schedule II of the Deed of Hypothecation describing the Hypothecated Assets to be released ("Release Request Letter").

The Trustee shall effectuate such release by issuing a no objection letter in response to the Release Request Letter and shall also, if requested by the Company execute all such documents as may be required for such release. The Release Request Letter shall be accompanied by a certificate from the independent chartered accountant of the Company confirming to the Debenture Trustee in writing the amount of Released Assets and that the Asset Cover Ratio shall be maintained post such excess release. The Debenture Trustee shall not be required to provide any notice to or obtain any consent of the Debenture Holders for issuing the non-objection letter and releasing the excess Hypothecated Assets under the terms hereof. The Trustee shall not be liable for any consequences for having acted in terms hereof and having made such release.

	The Released Assets shall not be construed to be a part of the Security and the Company shall be
	entitled to deal with the Released Assets in the manner it deems fit.
e e	Creation and Perfection The Company shall execute Debenture Trust Deed and Deed of Hypothecation prior to listing of the Debentures and perfect the same by filing requisite forms with ROC within 30 (Thirty) days, or such other time as permitted under Applicable Law, of creation of charge. The Issuer shall cooperate with the Trustee to enable it to make necessary filings in connection with the creation of Security over the Hypothecated Assets with the CERSAI, within the timelines as specified under Applicable Law from the date of creation of security over the Hypothecated Assets in respect of any Tranche/ Series. The Debentures shall be considered to be secured only in the event the Hypothecated Assets are registered with the relevant ROC or CERSAI or Depository, as applicable or is independently verifiable by the Trustee.
-	<u>Due Diligence</u> The Trustee shall exercise independent due diligence to ensure that the Security is free from any encumbrances in accordance with the applicable circulars / notifications issued by the SEBI including under the provisions of the Securities and Exchange Board of India (Debenture Trustees) Regulations, 1993 (as amended from time to time), and as also set out in detail under the terms of the Debenture Trustee Agreement.
Transaction Documents	Shelf Placement Memorandum, Tranche Placement Memorandum, Deed of Hypothecation, Debenture Trust Deed, Debenture Trustee Agreement and the Private Placement Offer Cum Application Letter, as amended from time to time, and any other document that may be designated by the Debenture Trustee as a Transaction Document.
Conditions Precedent to Disbursement	 The Issuer shall deliver to the Debenture Trustee, a certified true copy of the Issuer's constitutional documents, registration certificate and certificate of incorporation, as amended up-to-date; (i) The Issuer shall deliver to the Debenture Trustee, consent letter from the Debenture Trustee conveying their consent to act as Debenture Trustees for the Debenture Holder(s); (ii) The Issuer shall deliver to the Debenture Trustee, a certified true copy of the resolution of the Board of Directors authorising the issue of Debentures and also the execution of the necessary documents in that behalf; (iii) The Issuer shall obtain the in-principle approval for listing the Debentures on the WDM segment of the Stock Exchange; (iv) The Issuer shall deliver to the Debenture Trustee, a copy of the rating letters in relation to the Debentures issued by the Rating Agencies; (v) Due Diligence Certificate with respect to the Debentures. Such other Conditions Precedent as set out in the Transaction Documents.
Conditions Subsequent to Disbursement	 (i) Filing of the relevant documents required to be filed with the Registrar of Companies, inter alia, the return of allotment within the timelines specified under the Act and the rules made thereunder; (ii) Completion of listing of the Debentures on the WDM segment of the Stock Exchange; (iii) Credit of the Debentures in the demat account(s) of the allotees; Such other Conditions Subsequent as set out in the Transaction Documents.
Events of Default (including manner of voting /conditions of joining Inter Creditor Agreement)	As per Note 2 of the Shelf Placement Memorandum.
Creation of recovery expense fund	Details and purpose of the recovery expense fund: The Company has created a recovery expense fund with BSE and shall maintain the fund in the manner as specified in the SEBI Circular dated October 22, 2020 vide reference no. SEBI/HO/MIRSD/CRADT/CIR/P/2020/207 and as may be supplemented or amended from time to time, and inform the Debenture Trustee about the same. The recovery expense fund may be utilized by the Debenture Trustee upon occurrence of an Event of Default, for taking appropriate legal actions to enforce the Security in accordance with the relevant SEBI circulars.

Conditions for breach of	As set out under the head "All covenants of Issue" and "Events of Default" in the Shelf Placement		
covenants (as specified in Trust Deed)	Memorandum.		
Provisions related to Cross Default Clause	Nil		
Role and Responsibilities of Trustee	To oversee and monitor the overall transaction for and on behalf of the Debenture Holders as customary for transaction of a similar nature and size and as executed under the appropriate Transaction Documents.		
Risk factors pertaining to the Issue	As per the "Risk Factors" mentioned in Section O below.		
Governing Law and Jurisdiction	The Issue shall be governed by and construed in accordance with Indian Law. Please also refer to "Governing law" provisions set out below.		
Due Diligence Certificate	The Issuer shall submit the due diligence certificate provided by the Trustee, to BSE in accordance with the applicable SEBI regulations, including but not limited to the SEBI circular dated November 03, 2020 (bearing reference no SEBI/HO/MIRSD/CRADT/CIR/P/2020/218). Such due diligence certificate is annexed hereto.		
Manner of bidding in the issue	Open bidding		
Manner of settlement	Through Indian Clearing Corporation Limited (ICCL)		
Settlement cycle	Settlement shall be on T+1 day		
Manner of allotment	Uniform Price (Fixed Coupon bidding)		
Minimum Bid Lot	Rs.1,00,00,000 (Rupees One Crore Only) and in the Multiples of Rs.10,00,000/- (Rupees Ten Lakhs Only) thereafter.		
Terms and conditions of debenture trustee agreement including fees charged by debenture trustees(s), details of security to be created and process of due diligence carried out by the debenture trustee	Please refer to Annexure VI of the Shelf Placement Memorandum.		
Terms of raising of securities	Mode of Payment NEFT / RTGS		
	Mode of Electronic clearing services (ECS)/credit through RTGS system/funds transfer		

The Issuer shall maintain hundred per cent. asset cover sufficient to discharge the principal amount at all times for the non-convertible debt securities issued. The Company shall provide a half-yearly certificate regarding maintenance of hundred percent asset cover including compliance with all the covenants, in respect of listed non-convertible debt securities, by the statutory auditor, along with the half-yearly financial results.

General Notes:

- a. If there is any change in Coupon Rate pursuant to any event including lapse of certain time period or downgrade in rating, then such new Coupon Rate and events which lead to such change shall be disclosed by the Company.
- b. The list of documents which has been executed in connection with the issue and subscription of debt securities is annexed with this Tranche Placement Memorandum.
- c. While the debt securities are secured to the tune of 110% of the principal and interest amount or as per the terms of the Disclosure Documents, in favour of Debenture Trustee, it is the duty of the Debenture Trustee to monitor that the Security is maintained.

Illustration of Cash flows

Series 2022 / 181 - Series 2022 A/0(ZC)/181_Option 1

Series 2022 / 181 - Series 2022 A/1(FX)/181_Option 2

Name of the Issuer	HDB Financial Services Limited			
Security Name	HDB/0%/Premium/2025_ Series 2022 A/0(ZC)/181_Option 1 HDB/7.70%/Annual/2025_ Series 2022 A/1(FX)/181_Option 2			
Face Value (per security)	Rs.10,00,000/- (Rupees Ten Lakhs Only) per Debenture			
Deemed Date of Allotment	Thursday, July 07, 2022			
Tenor	1096 days from the deemed date of allotment i.e. Thursday, July 07, 2022	1131 days from the deemed date of allotment i.e. Thursday, July 07, 2022		
Redemption Date	Monday, July 07, 2025	Monday, August 11, 2025		
Coupon Rate	Zero Coupon	7.7000% p.a.		
Frequency of the interest payment with specified dates	N.A.	Thursday, 11 August, 2022 Friday, 11 August, 2023 Sunday, 11 August, 2024 & on maturity Monday, 11 August, 2025		
Day Count Convention	Actual/Actual			

Series 2022 / 181 - Series 2021 A/0(ZC)/181_Option 1

Cash Flows	Date	Day	No. Of Days in Coupon Period	Amount in Rupees per debenture of Rs.10 lakh
Principal Inflow	July 07, 2022	Thursday	N.A.	(10,00,000.00)
Principal Repayment	July 07, 2025	Monday	N.A.	12,49,497.00

Series 2022 / 181 - Series 2022 A/1(FX)/181_Option 2

Cash Flows	Date	Day	No. Of Days in Coupon Period	Amount in Rupees per debenture of Rs.10 lakh
Principal Inflow	July 07, 2022	Thursday	N.A.	(10,00,000.00)
1st coupon	August 11, 2022	Thursday	35	7,383.56
2 nd coupon	August 11, 2023	Friday	365	77,000.00
3 rd coupon	August 11, 2024	Sunday	366	77,000.00
4 th coupon	August 11, 2025	Monday	365	77,000.00
Principal Repayment	August 11, 2025	Monday	N.A.	10,00,000.00

MANNER OF SETTLEMENT

- The eligible investors should complete the funds pay-in to the designated bank account of the Indian Clearing Corporation Ltd (ICCL) by 10:30 am on T+1 day.
- The participants must ensure to do the funds pay-in from the same bank account which is updated by them in the EBP platform while placing the bids.
- · The Designated Bank Accounts of ICCL are as under:

Name of Bank	HDFC BANK
IFSC Code	HDFC0000060
Account number	ICCLEB
Name of beneficiary	INDIAN CLEARING CORPORATION LIMITED

Name of Bank	ICICI Bank Ltd.
IFSC Code	ICIC0000106
Account number	ICCLEB
Name of beneficiary	INDIAN CLEARING CORPORATION LTD

Name of Bank	YES BANK
IFSC Code	YESB0CMSNOC
Account number	ICCLEB
Name of beneficiary	INDIAN CLEARING CORPORATION LTD

- In the event of the issue getting withdrawn, the funds refund would be initiated on T+1 day.
- In case of mismatch in the bank account details between biding platform and the bank account from which payment
 is done by the eligible investors, the payment would be returned back. Further, pay-in received from any other bank
 account may lead to cancellation of bid and consequent debarment of the bidder from accessing EBP Platform for
 30 days.
- Securities Settlement: Depositories will credit the securities to the demat account of the respective investor.

For HDB Financial Services Limited

Authorised Signatory Name: Jaykumar Shah

Title: Chief Financial Officer

Date: July 06, 2022

Encl: Due Diligence Certificate issued by the Debenture Trustee

IDBI Trusteeship Services Ltd

CIN: U65991MH2001GOI131154

No. 46330/ITSL/OPR/2022-23

(T) IDBI trustee

To, BSE Limited 25th Floor, P.J. Towers, Dalai Street, Mumbai – 400 001

DUE DILIGENCE CERTIFICATE TO BE GIVEN BY THE DEBENTURE TRUSTEE AT THE TIME OF FILING THE DRAFT OFFER DOCUMENT OR INFORMATION MEMORANDUM

Dear SinMadam

SUB: The total issue size aggregating of INR 1000 crores (Rs. 25 Crore with Green Shoe Option of upto Rs 475 Crore Option 1 and Rs 25 Crore with Green Shoe Option of upto Rs 475 Crore Option 2) under Umbrella Consent of INR 10,000 crores by HDB Financial Services Limited.

We, the debenture trustee(s) to the above-mentioned forthcoming issue state as follows:

- We have examined documents pertaining to the said issue and other such relevant documents, reports and certifications.
- 2) On the basis of such examination and of the discussions with the Issuer, its directors and other officers, other agencies and on independent verification of the various relevant documents, reports and certifications:

We confirm that:

- The Issuer has made adequate provisions for and/or has taken steps to provide for adequate security for the debt securities to be issued.
- The Issuer has obtained the permissions / consents necessary for creating security on the said property (ies).
- c) The Issuer has made all the relevant disclosures about the security and its continued obligations towards the holders of debt securities.
- d) Issuer has adequately disclosed all consents/ permissions required for creation of further charge on assets in offer document or private placement memorandum/ information memorandum and all disclosures made in the offer document or private placement memorandum/ information memorandum with respect to creation of security are in confirmation with the clauses of debenture trustee agreement.
- Issuer has given an undertaking that charge shall be created in favour of debenture trustee as per terms
 of issue before filing of listing application.
- f) Issuer has disclosed all covenants proposed to be included in debenture trust deed (including any side letter, accelerated payment clause etc.), offer document or private placement memorandum/ information memorandum and given an undertaking that debenture trust deed would be executed before filing of listing application.
- g) All disclosures made in the draft offer document or private placement memorandum/ information memorandum with respect to the debt securities are true, fair and adequate to enable the investors to make a well-informed decision as to the investment in the proposed issue.

We have satisfied ourselves about the ability of the Issuer to service the debt securities.

PLACE: Mumbai DATE: July 01, 2022

For IDBI Trusteeship Services Limited Authorised Signatory

Regd. Office: Asian Building, Ground Floor, 17, R. Kamani Marg, Ballard Estate, Mumbal - 400 001. Tel.: 022-4080 7000 • Fax: 022-6631 1776 • Email: itsl@idbitrustee.com • response@idbitrustee.com Website: www.idbitrustee.com